**Pin Assignments** 

A1

B1

Applications

Cellular Phones

**Digital Cameras** 

Portable PCs and PDAs

Ο

(Top View)

A2

B2

Portable and Battery Powered Applications



#### MINIATURE MICROPOWER OMNIPOLAR HALL EFFECT SWITCH

(Bottom View)

A2

B2

A1

B1

AH1891

### Description

The AH1891 is a minature micropower Omnipolar Hall effect switch IC with dual outputs, specifically designed for portable and battery powered equipment such as cellular phones and portable PCs. To support battery powered equipment the AH1891 is optimized to operate over the supply range of 1.8V to 3.3V and uses a sleep function to give an average supply current of only 7 $\mu$ A. To minimize PCB space the AH1891 is packaged in the small CSP package (0.8mmx0.8mm) and the design integrates the external pull up resistors to simplify the applications circuit.

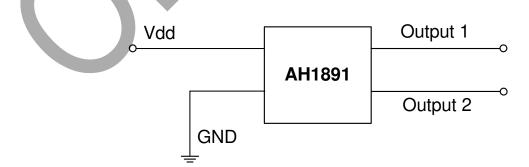
The outputs of the AH1891 are switched with either a North or South pole of sufficient strength. When the magnetic flux density (B) is larger than operate point (Bop), Output 1 will pull low and Output 2 will be inverted (high). The output states are held until B is lower than release point (Brp).

The AH1891 is available in U-WLB0808-4 package.

#### **Features**

- Omnipolar (North or South) operation
- Low Supply Voltage of 1.8V to 3.3V
- Micropower Operation
- Dual Outputs for Design Flexibility
- Internal Pull Up and Pull Down Capability
- Chopper stabilized design for:
  - Superior temperature stability
  - Superior temperature stability
- Superior temperature stability
- Good RF Noise Immunity
- -40°C to 85°C Operating Temperature
- ESD > 4KV in Human Body Mode
- Miniature CSP package 0.8mm x 0.8mm

## **Typical Application Circuit**



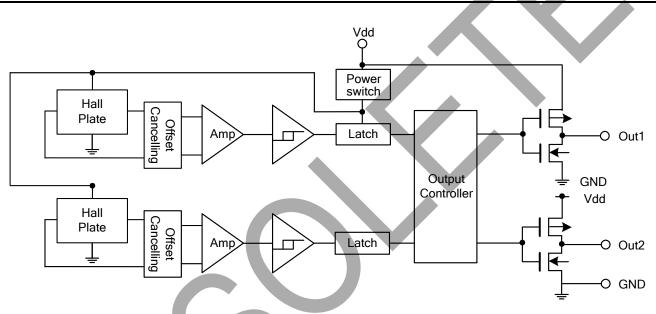
## AH1891 Document number: DS35207 Rev. 2 - 4



### **Pin Descriptions**

Pin #	Pin Name	Description
A1	Out 1	Output Pin ( active low )
A2	Out 2	Output Pin (active high)
B1	GND	Ground
B2	Vdd	Power Supply Voltage

### Functional Block Diagram



# Absolute Maximum Ratings (T<sub>A</sub> = 25°C)

Symbol	Parameter	Values	Unit			
Vdd	Supply voltage	5	V			
В	Magnetic flux density	Unlimited				
T <sub>A</sub>	Operating Temperature Range	-40 to +85	°C			
Ts	Storage Temperature Range	-65 to +150	°C			
PD	Package Power Dissipation	166	mW			
TJ	Maximum Junction Temperature	150	°C			

# Recommended Operating Conditions (T<sub>A</sub> = 25°C)

Symbol	Parameter	Conditions	Rating	Unit	
Vdd	Supply Voltage	Operating	1.8 to 3.3	V	



### Electrical Characteristics (T<sub>A</sub> = +25°C, Vdd = 1.8V, unless otherwise specified)

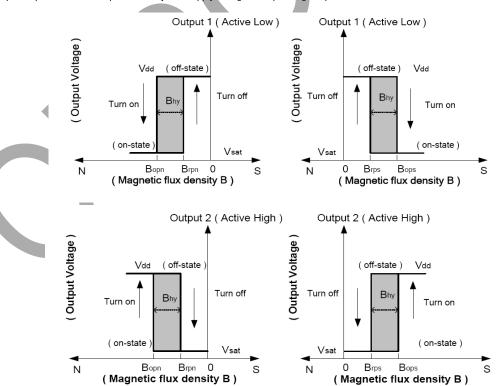
Symbol	Parameter	Conditions	Min	Тур.	Max	Unit
V <sub>OH</sub>	Output On Voltage (High side)	I <sub>0</sub> = -0.5mA	Vdd-0.2	-	-	V
Vol	Output On Voltage (Low side)	I <sub>O</sub> = 0.5mA	-	-	0.2	V
loff	Output Leakage Current	Output off	-	<0.1	1	μA
ldd(en)		Chip enable	-	2	4	mA
ldd(dis)	Supply Current	Chip disable	-	5	8	μA
ldd(avg)		Average supply current	-	7	12	μA
Tawake	Awake Time	-	-	50	100	μs
Tperiod	Period	-	-	50	100	ms
D.C.	Duty Cycle	-	-	0.1	-	%

#### Magnetic Characteristics (T<sub>A</sub> = 25°C, Vdd = 1.8V~3.3V, Note 1)

				(1mT=10 Gauss)		
Symbol	Parameter (Note 2)	Min	Тур.	Max	Unit	
Bops(south pole to brand side)	Operate Deint	20	40	60		
Bopn(north pole to brand side)	Operate Point	-60	-40	-20		
Brps(south pole to brand side)	Release Point	12	25	50	Gauss	
Brpn(north pole to brand side)	Release Point	-50	-25	-12		
Bhy( Bopx - Brpx )	Hysteresis		15	-		

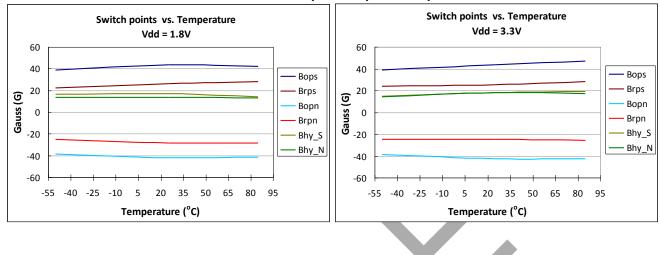
Notes: 1. Typical data is at  $T_A = 25^{\circ}C$ , Vdd = 3V, and for design information only.

2. Operate point and release point will vary with supply voltage and operating temperature.



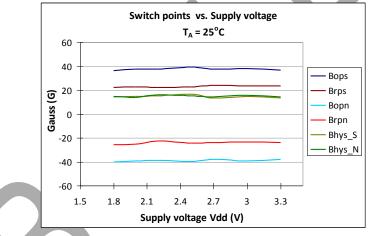


### **Typical Operating Characteristics**

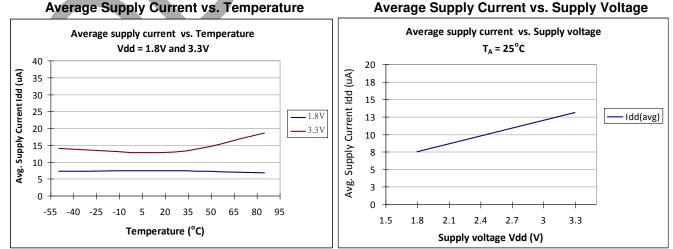


#### Switch Points Bop and Brp vs. Temperature





Average Supply Current vs. Temperature

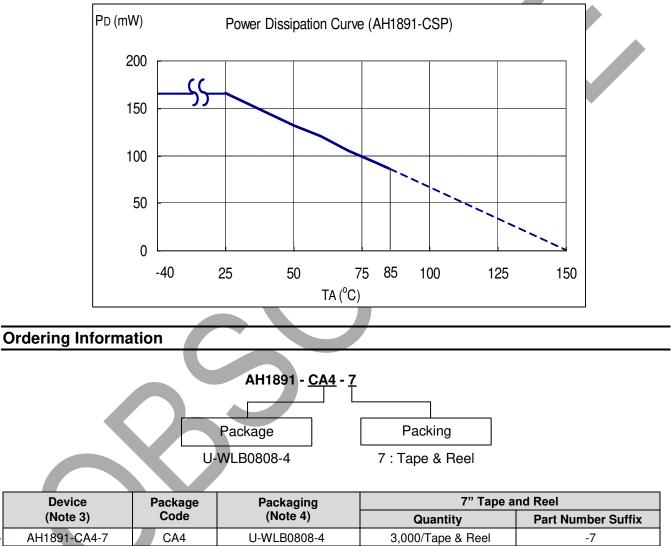




#### **Performance Characteristics**

#### (1) U-WLB0808-4

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
$P_D (mW)$	166	132	120	105	93	86	79	66	53	39	26	13	0



Notes: 3

Pb,

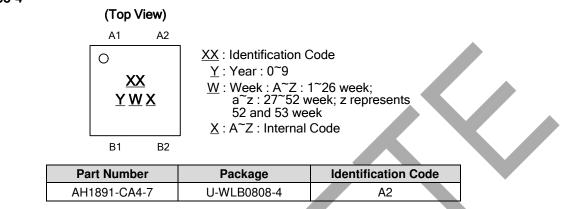
 EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead\_free.html.

 Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.



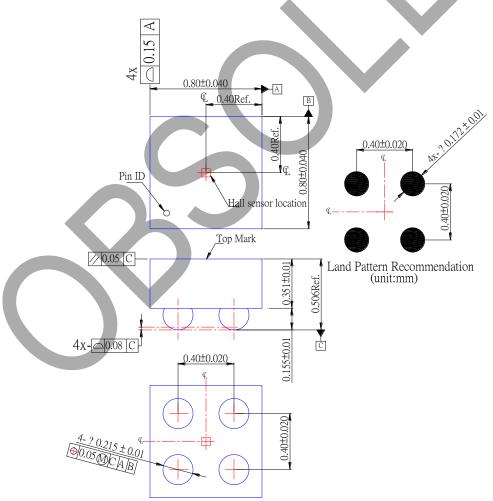
### **Marking Information**

#### (1) U-WLB0808-4



### Package Outline Dimensions (All Dimensions in mm)

#### (1) Package type: U-WLB0808-4





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